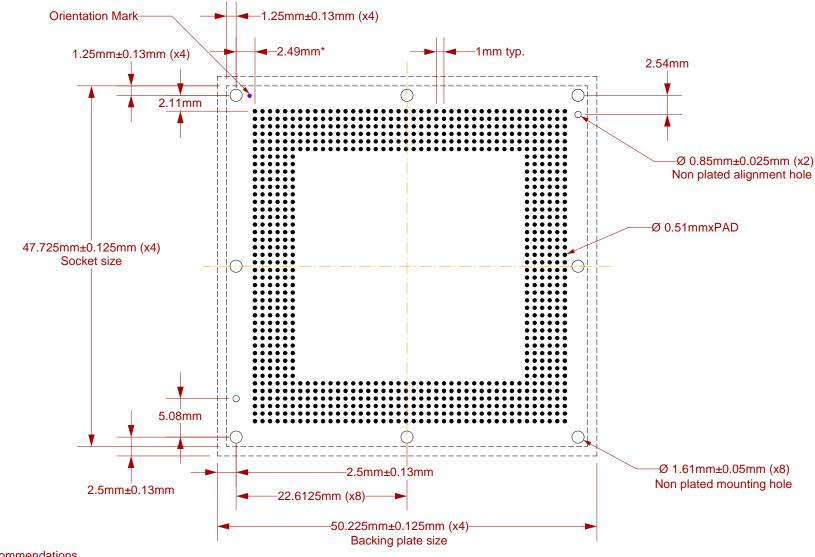


SG-BGA-6041 Drawing	Status: Released	Scale: -		Rev: F	All tolerances: ±0.125mm (unless stated otherwise). Materials and specifications
© 2009 IRONWOOD ELECTRONICS, INC. 11351 Rupp Drive, Suite 400, Burnsville, MN 55337	Drawing: Heidi Hansen		Date: 3/11/02		are subject to change without notice.
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Recommended PCB Layout Top View



Target PCB Recommendations

Total thickness: 2.4mm min.

Plating: Gold or Solder finish

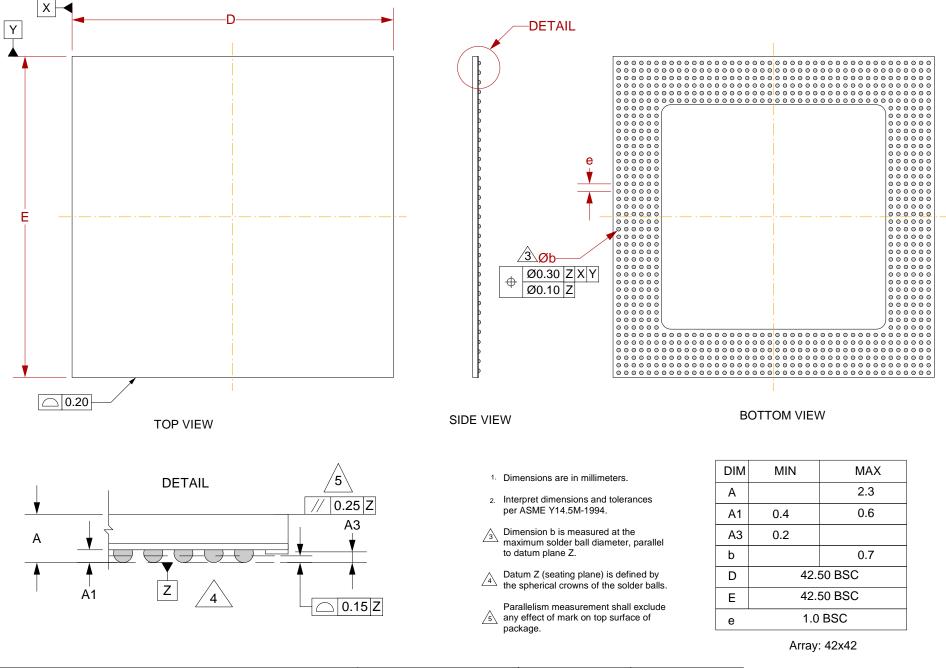
PCB Pad height: Same or higher than solder mask

NOTE: Steel backing plate may be required based on end user's application

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.

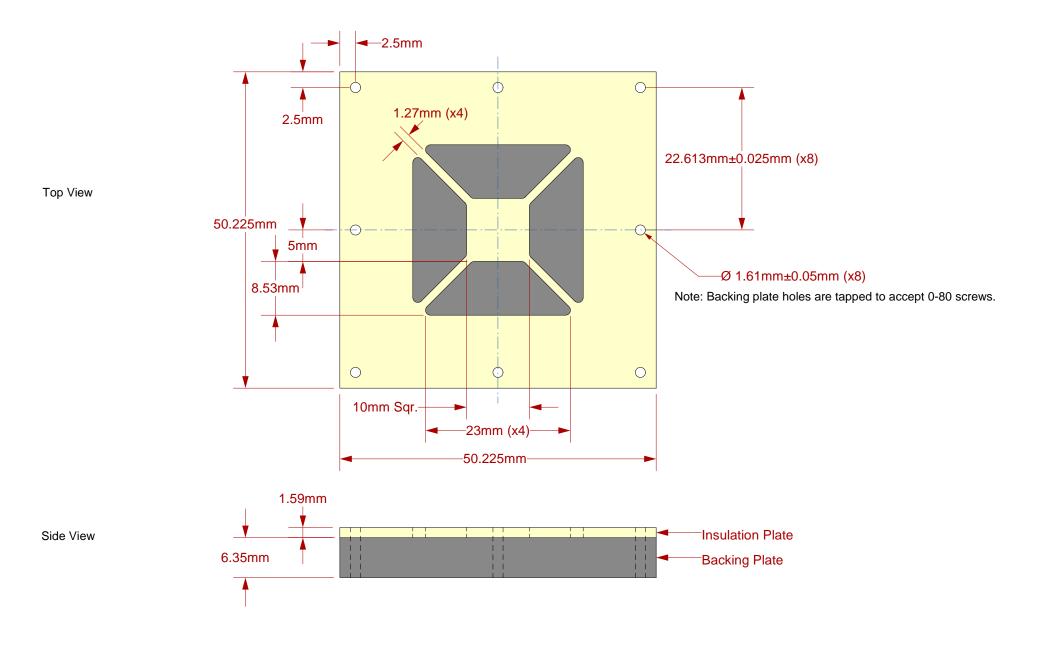
SG-BGA-6041 Drawing	Status: Released		: 2:1	Rev: F
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SG-BGA-6041 Dr	GA-6041 Drawing Status: Released Scal		Scale: -		Rev: F
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		File: SG-BGA-6041 Dwg		Modified: 7/16/09, AE	

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## Description: Insulation Plate and Backing Plate

SG-BGA-6041 Drawing	SG-BGA-6041 Drawing Status: Released Sca		: -	Rev: F	
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Tele: (952) 229-8200 www.ironwoodelectronics.com	File: SG-BGA-6041 Dwg		Modified: 7/16/09, AE		

All dimensions are in mm. All tolerences are +/- 0.125mm. (Unless stated otherwise)

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